54ACT16544 . . . WD PACKAGE 74ACT16544 . . . DL PACKAGE (TOP VIEW)

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•	Members of the Texas Instruments
	<i>Widebus</i> ™ Family

- Inputs Are TTL-Voltage Compatible
- **3-State Inverted Outputs**
- Flow-Through Architecture Optimizes **PCB** Layout
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- **EPIC<sup>™</sup>** (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

#### description

The 'ACT16544 are 16-bit registered transceivers that contain two sets of D-type latches for temporary storage of data flowing in either direction. They can be used as two 8-bit transceivers or one 16-bit transceiver. Separate latch-enable (LEAB or LEBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

The A-to-B enable (CEAB) input must be low to enter data from A or to output data to B. Having CEAB low and LEAB low makes the A-to-B latches transparent; a subsequent low-to-high transition at LEAB puts the A latches in the storage mode. Data flow from B to A is similar, but requires using the CEBA, LEBA, and OEBA inputs.

The 74ACT16544 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16544 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16544 is characterized for operation from -40°C to 85°C.



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	•		
1 <del>0EAB</del>		56	10EBA
1LEAB	2	55	1LEBA
1CEAB	3	54	1CEBA
gnd [	4	53	GND
1A1 [	5	52	] 1B1
1A2 🛛	6	51	] 1B2
v <sub>cc</sub> [	7	50	] v <sub>cc</sub>
1A3 [	8	49	] 1B3
1A4 [	9		] 1B3 ] 1B4
1A5 🛛	10		1B5
GND [	11		GND
1A6 [	12	45	1B6
1A7 [	13	44	1B7
1A8 [	14	-	1B8
2A1 [	15		2B1
2A2 [	16	41	2B2
2A3 [	17		2B3
GND	18		GND
2A4 [		38	2B4
2A5	20	37	2B5
2A6 [	21	36	2B6
V <sub>CC</sub> L	22		V <sub>CC</sub>
2A7 🛛	23	34	2B7
2A8 [	24	33	2B8
GND	25	32	GND
2CEAB	26		2CEBA
2LEAB	27	30	2LEBA
20EAB	28	29	20EBA

# 54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS161A – AUGUST 1990 – REVISED APRIL 1996

#### FUNCTION TABLE<sup>†</sup>

	INP	OUTPUT		
CEAB	LEAB	OEAB	Α	В
н	Х	Х	Х	Z
L	Х	Н	Х	Z
L	н	L	х	в <sub>0</sub> ‡
L	L	L	L	н
L	L	L	Н	L

<sup>†</sup> A-to-B data flow is shown: <u>B-to-A flow control is the</u> same except that it uses CEBA, LEBA, and OEBA. <sup>‡</sup> Output level before the indicated steady-state input conditions were established



#### 54ACT16544, 74ACT16544 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS SCAS161A – AUGUST 1990 – REVISED APRIL 1996

logic symbol<sup>†</sup>



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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## logic diagram (positive logic)



**To Seven Other Channels** 



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub> Input voltage range, V <sub>I</sub> (see Note 1)	5 to V <sub>CC</sub> + 0.5 V 5 to V <sub>CC</sub> + 0.5 V ±20 mA ±50 mA ±50 mA ±400 mA 1.4 W
Maximum power package dissipation at $T_A = 55^{\circ}C$ (see Note 2): DL package Storage temperature range, $T_{stg}$	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

#### recommended operating conditions (see Note 3)

		54	ACT1654	44	74	ACT1654	44	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2	4	ΞW	2			V
VIL	Low-level input voltage		ng.	0.8			0.8	V
VI	Input voltage	0	PP	VCC	0		VCC	V
Vo	Output voltage	0	5	VCC	0		VCC	V
ЮН	High-level output current	4	20	-24			-24	mA
IOL	Low-level output current	R	)	24			24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	0		10	ns/V
ТА	Operating free-air temperature	-55		125	-40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



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## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

БА	DAMETED	TEST CONDITIONS	V	T,	<b>₄ = 25°C</b>	;	54ACT	16544	74ACT	6544	UNIT
FA	RAMETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			4.5 V	4.4			4.4		4.4		
		I <sub>OH</sub> = -50 μA	5.5 V	5.4			5.4		5.4		
Vон		I <sub>OH</sub> = -24 mA	4.5 V	3.94			3.8		3.8		V
		IOH = -24 IIIA	5.5 V	4.94			4.8		4.8		
		$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85	ΞW	3.85		
		I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1		0.1	
		$OL = 30 \mu A$	5.5 V			0.1		0.1		0.1	V
VOL		le: - 24 mA	4.5 V			0.36	ζ2	0.44		0.44	
		I <sub>OL</sub> = 24 mA	5.5 V			0.36	$n_{Q}$	0.44		0.44	
		I <sub>OL</sub> = 75 mA <sup>†</sup>	5.5 V				b <sub>C</sub>	1.65		1.65	
Ц	Control inputs	$V_I = V_{CC}$ or GND	5.5 V			±0.1	Y	±1		±1	μΑ
loz‡	A or B ports	$V_{O} = V_{CC} \text{ or } GND$	5.5 V			±0.5		±5		±5	μA
ICC	-	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			8		80		80	μA
∆ICC§		One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	5.5 V			0.9		1		1	mA
Ci	Control inputs	VI = V <sub>CC</sub> or GND	5 V		4.5						pF
Cio	A or B ports	V <sub>O</sub> = V <sub>CC</sub> or GND	5 V		12						pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>‡</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

§ This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

## timing requirements over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

			T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C 54ACT1654		74ACT16544		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
tw	Pulse duration	LEAB or LEBA low	5.5		5.5	~	5.5		ns
	Satur time	Data before LEAB or LEBA↑	1.5		1.5	h.C	1.5		ns
t <sub>su</sub>	Setup time	Data before CEAB or CEBA↑	1.5		1.5	N.	1.5		
	Hold time	Data after LEAB or LEBA↑	3		3	-	3		20
th		Data after CEAB or CEBA↑	3		3		3		ns



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# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

	FROM	то	Т	T <sub>A</sub> = 25°C		54ACT16544		74ACT16544		
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A or B	B or A	2.8	6.7	10	2.8	11.2	2.8	11.2	ns
<sup>t</sup> PHL	AOIB	BUIA	4	7.5	10	4	11.2	4	11.2	115
<sup>t</sup> PLH	LEBA or LEAB	A or B	2.7	9	13.3	2.7	14	2.7	14	ns
<sup>t</sup> PHL		AUID	2.8	8.5	12.1	2.8	13.5	2.8	13.5	115
<sup>t</sup> PZH	CEBA or CEAB	A or B	3.2	7.2	10.5	3.2	2 11.7	3.2	11.7	
<sup>t</sup> PZL		AUD	3.8	8.2	12	3.8	13.6	3.8	13.6	ns
<sup>t</sup> PHZ	CEBA or CEAB	A or B	5.8	8.2	10.3	5.8	11.1	5.8	11.1	ns
<sup>t</sup> PLZ	CEBA or CEAB	AUID	5	7.4	9.4	05	10.2	5	10.2	115
<sup>t</sup> PZH		A or P	2.8	6.9	10.2	<b>2</b> 2.8	11.4	2.8	11.4	
<sup>t</sup> PZL	OEBA or OEAB	A or B	3.6	7.9	11.7	3.6	13.3	3.6	13.3	ns
<sup>t</sup> PHZ		A or B	5.2	7.7	9.8	5.2	10.5	5.2	10.5	
<sup>t</sup> PLZ	OEBA or OEAB	AUD	3.4	6.8	8.8	3.4	9.6	3.4	9.6	ns

## operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER			TEST CO	TYP	UNIT	
Γ	<u> </u>	Power dissipation capacitance per transceiver	Outputs enabled $C_1 = 50 \text{ pF}, \text{ f} = 1 \text{ N}$	f = 1 MHz	60	nE.	
L	Cpd	Power dissipation capacitance per transceiver	Outputs disabled	CL = 50 pr,			pF



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#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 3 ns, t<sub>f</sub> = 3 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms



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